# Freescale Semiconductor

Technical Data

Document Number: MMG2401 Rev. 3, 5/2006

**MMG2401NR2** 

2400-2500 MHz, 27.5 dB, 26.5 dBm

802.11g WLAN POWER AMPLIFIER InGaP HBT

# **VRoHS**

# Indium Gallium Phosphorus HBT WLAN Power Amplifier

Designed for 802.11g and dual mode applications with frequencies from 2400 to 2500 MHz.

- 26.5 dBm P1dB @ 2450 MHz
- Power Gain: 27.5 dB Typ (@ f = 2450 MHz, Class AB)
- High Gain, High Efficiency and High Linearity
- EVM = 3% Typ @ P<sub>out</sub> = +19 dBM, 14% PAE
- RoHS Compliant
- In Tape and Reel. R2 Suffix = 1,500 Units per 12 mm, 7 inch Reel.



### Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
Collector Supply	V <sub>CC</sub>	5	V
Base Supply First Stage	V <sub>B1</sub>	5	V
Base Supply Second Stage	V <sub>B2</sub>	5	V
Detector Bias Supply	V <sub>BIAS</sub>	5	V
DC Current	I <sub>DC</sub>	171	mA

### **Table 2. Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	185 (1)	°C/W
Case Operating Temperature Range	T <sub>C</sub>	- 40 to +85	°C
Storage Temperature Range	T <sub>stg</sub>	- 55 to +150	°C

### **Table 3. ESD Protection Characteristics**

Test Methodology	Class
Human Body Model (per JESD22-A114)	2 (Minimum)
Machine Model (per EIA/JESD22-A115)	A (Minimum)
Charge Device Model (per JESD22-C101)	II (Minimum)

### Table 4. Moisture Sensitivity Level

Test Methodology	Rating	Package Peak Temperature	Unit
Per JESD 22-A113, IPC/JEDEC J-STD-020	1	260	°C

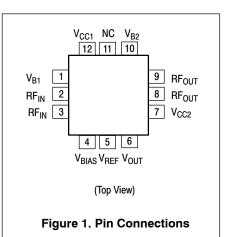
1. Simulated.

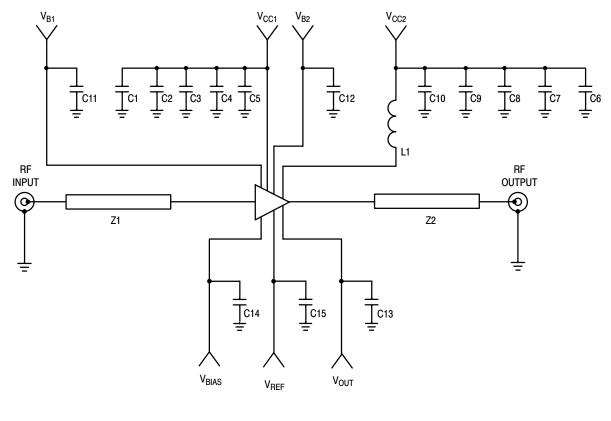


Characteristic	Symbol	Min	Тур	Max	Unit
Output Power at 1dB Compression	P1dB	24	26.5	_	dBm
Power Gain (P <sub>out</sub> = 19 dBm)	G <sub>p</sub>	26	27.5	29	dB
Error Vector Magnitude (P <sub>out</sub> = 19 dBm, 64 QAM/54 Mbps)	EVM		3	_	%
Total Current (P <sub>out</sub> = 19 dBm)	I <sub>Ctotal</sub>		210	_	mA
Quiescent Current	IDCQ	_	156	_	mA
Bias Control Reference Current (I <sub>CQ</sub> = 66 mA)	I <sub>ref</sub>		8.4	_	mA
Gain Flatness (Over 100 MHz)	G <sub>F</sub>		±0.2	_	dB
Gain Variation over Temperature (-40 to 85°C)	-		±1	_	dB
Input Return Loss	IRL	_	- 10	-7.5	dB
Reverse Isolation	—	_	-35	_	dB
Second Harmonic (P <sub>out</sub> = 19 dBm)	-		-45	_	dBc
Third Harmonic (P <sub>out</sub> = 19 dBm)	-		-35	_	dBc
Ramp-On Time (10-90%)	t <sub>ON</sub>	_	100	_	ns

Table 5. Electrical Characteristics (T<sub>A</sub> = 25°C unless otherwise noted.) V<sub>CC</sub> = 3.3 Vdc, V<sub>BIAS</sub> = 3 Vdc, I<sub>CQ</sub> = 83 mA, f = 2450 MHz

Name	Pin Number	Description		
V <sub>B1</sub>	1	Base power supply for first stage amplifier.		
RF <sub>IN</sub>	2, 3	RF input for the power amplifier. This pin is DC-shorted to GND and AC-coupled to the transistor base of the first stage.		
V <sub>BIAS</sub>	4	Detector bias voltage supply.		
V <sub>REF</sub>	5	Detector output voltage reference. V <sub>out</sub> - V <sub>REF</sub> is useful for tracking detector performance over temperature.		
V <sub>OUT</sub>	6	Detector output voltage.		
V <sub>CC2</sub>	7	Collector power supply for second stage amplifier.		
RF <sub>OUT</sub>	8, 9	RF output for the power amplifier. This pin is DC-coupled and requires a DC-blocking series capacitor.		
V <sub>B2</sub>	10	Base power supply for second stage amplifier.		
NC	11	Not connected.		
V <sub>CC1</sub>	12	Collector power supply for first stage amplifier.		
GND	Backside Center Metal	The center metal base of the QFN 3x3 package provides both DC and RF ground as well as heat sink contact for the power amplifier.		

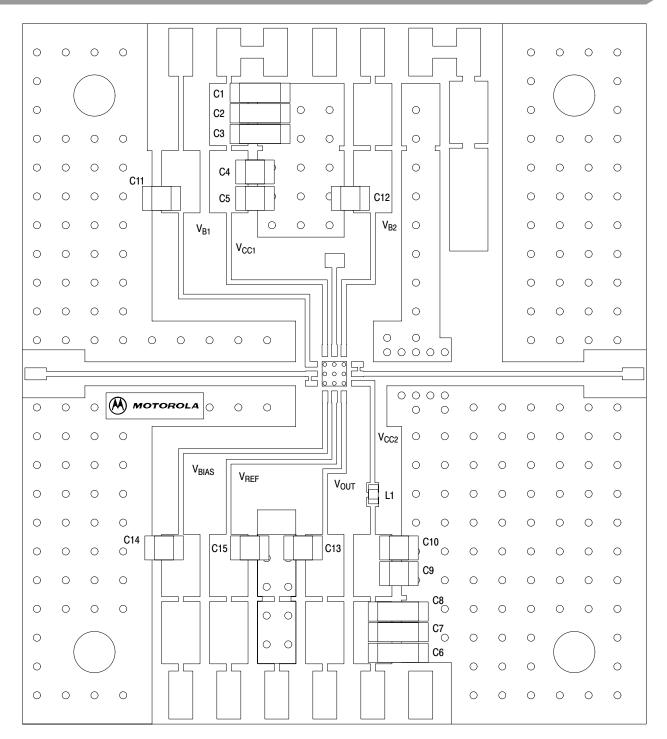




Z1, Z2	0.10" x 0.5395" Microstrip
PCB	Getek ML200M, 0.005", $\epsilon_r = 3.8$



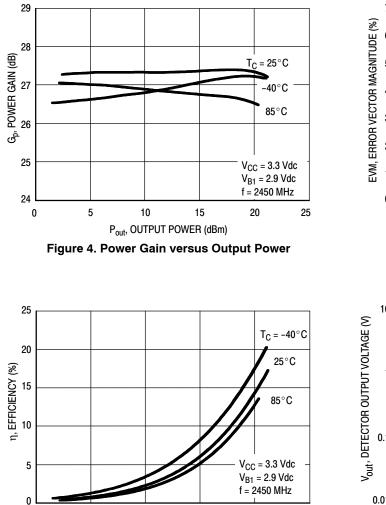
Part	Description	Part Number	Manufacturer
C1, C6	1 μF Chip Capacitor	12065A105JAT2A	AVX
C2, C7	0.1 µF Chip Capacitor	12065A104JAT2A	AVX
C3, C8	0.01 µF Chip Capacitor	12065A103JAT2A	AVX
C4, C9, C11, C12	100 pF Chip Capacitor	08055A101FAT2A	AVX
C5, C10, C13, C14, C15	20 pF Chip Capacitor	12065A200CAT2A	AVX
L1	7.5 nH Chip Inductor	0402CS-7N5XJBC	Coilcraft



Freescale has begun the transition of marking Printed Circuit Boards (PCBs) with the Freescale Semiconductor signature/logo. PCBs may have either Motorola or Freescale markings during the transition period. These changes will have no impact on form, fit or function of the current product.

Figure 3. MMG2401NR2 Test Circuit Component Layout

## **TYPICAL CHARACTERISTICS**



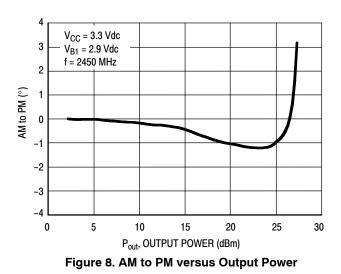
P<sub>out</sub>, OUTPUT POWER (dBm) Figure 6. Efficiency versus Output Power

15

20

25

10





0

5

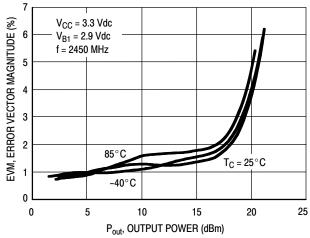


Figure 5. Error Vector Magnitude versus Output Power

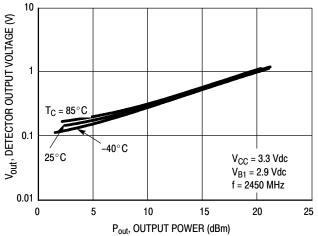


Figure 7. Detector Output Voltage versus Output Power

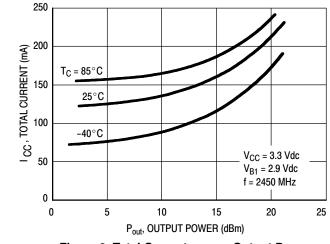
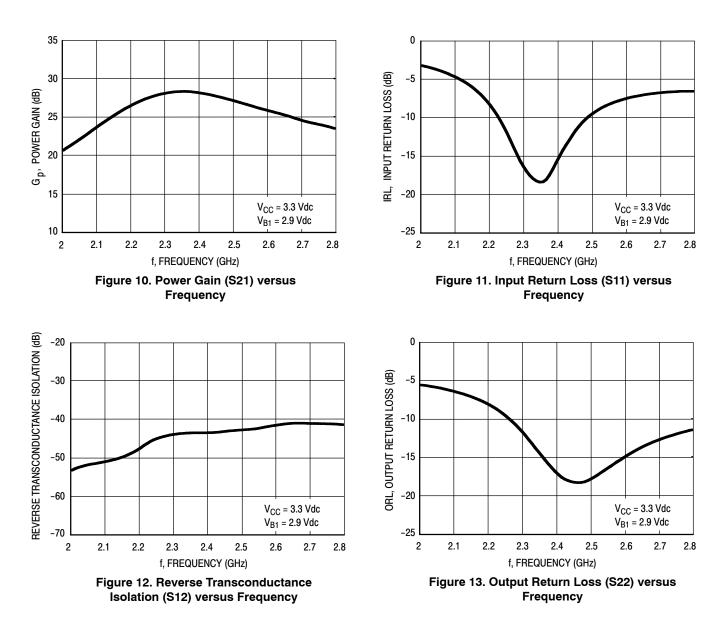


Figure 9. Total Current versus Output Power

# TYPICAL CHARACTERISTICS



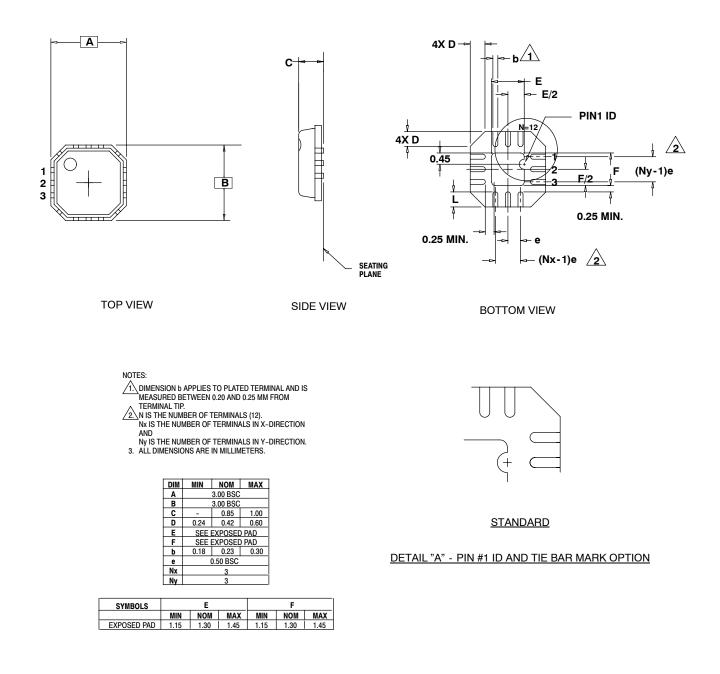
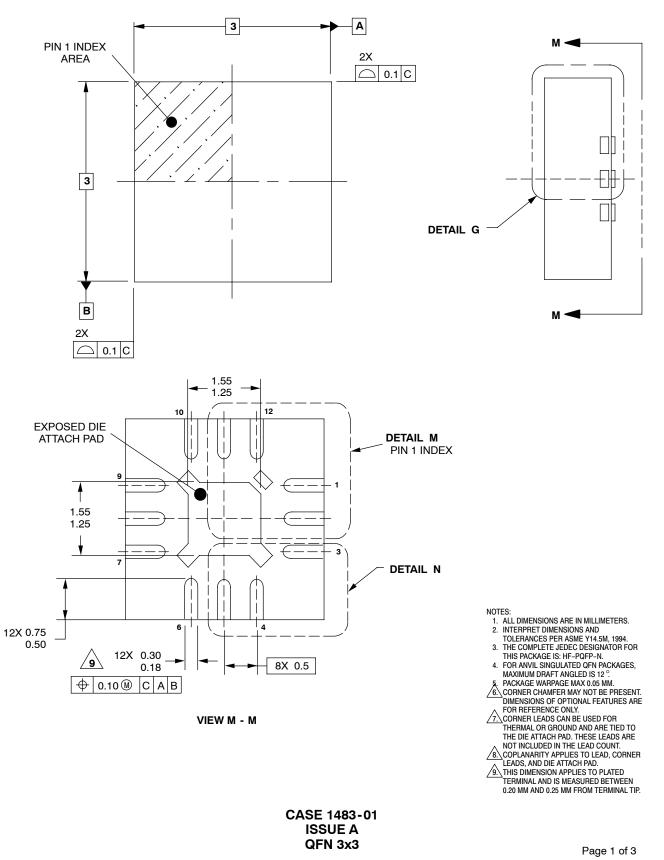
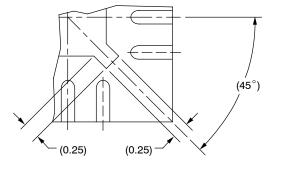


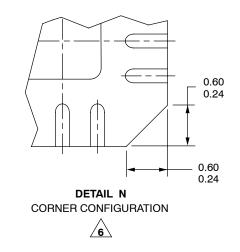
Figure 14. MMG2401NR2 Specific Mechanical Outline Information

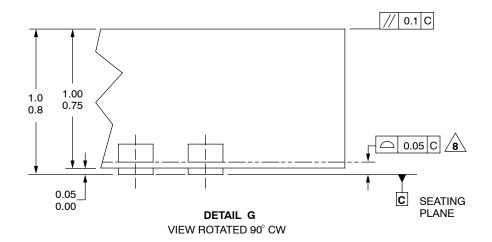
# PACKAGE DIMENSIONS





DETAIL N PREFERRED CORNER CONFIGURATION



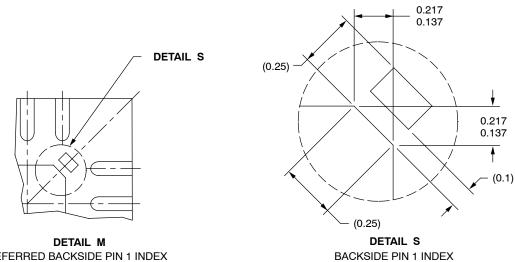


CASE 1483-01 ISSUE A QFN 3x3

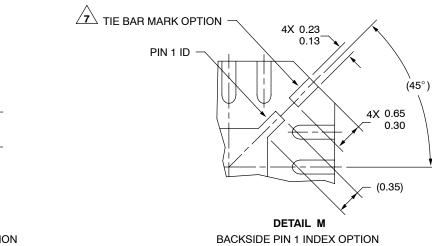
Page 2 of 3

RF Device Data Freescale Semiconductor

# MMG2401NR2







(0.45) R0.2 -PIN 1 ID DETAIL M BACKSIDE PIN 1 INDEX OPTION

> CASE 1483-01 **ISSUE A** QFN 3x3

> > Page 3 of 3

## How to Reach Us:

#### Home Page: www.freescale.com

E-mail: support@freescale.com

#### **USA/Europe or Locations Not Listed:**

Freescale Semiconductor Technical Information Center, CH370 1300 N. Alma School Road Chandler, Arizona 85224 +1-800-521-6274 or +1-480-768-2130 support@freescale.com

#### Europe, Middle East, and Africa:

Freescale Halbleiter Deutschland GmbH Technical Information Center Schatzbogen 7 81829 Muenchen, Germany +44 1296 380 456 (English) +46 8 52200080 (English) +49 89 92103 559 (German) +33 1 69 35 48 48 (French) support@freescale.com

#### Japan:

Freescale Semiconductor Japan Ltd. Headquarters ARCO Tower 15F 1-8-1, Shimo-Meguro, Meguro-ku, Tokyo 153-0064 Japan 0120 191014 or +81 3 5437 9125 support.japan@freescale.com

#### Asia/Pacific:

Freescale Semiconductor Hong Kong Ltd. Technical Information Center 2 Dai King Street Tai Po Industrial Estate Tai Po, N.T., Hong Kong +800 2666 8080 support.asia@freescale.com

### For Literature Requests Only:

Freescale Semiconductor Literature Distribution Center P.O. Box 5405 Denver, Colorado 80217 1-800-441-2447 or 303-675-2140 Fax: 303-675-2150 LDCForFreescaleSemiconductor@hibbertgroup.com RoHS-compliant and/or Pb- free versions of Freescale products have the functionality and electrical characteristics of their non-RoHS-compliant and/or non-Pb- free counterparts. For further information, see http://www.freescale.com or contact your Freescale sales representative.

For information on Freescale.s Environmental Products program, go to http://www.freescale.com/epp.

Information in this document is provided solely to enable system and software implementers to use Freescale Semiconductor products. There are no express or implied copyright licenses granted hereunder to design or fabricate any integrated circuits or integrated circuits based on the information in this document.

Freescale Semiconductor reserves the right to make changes without further notice to any products herein. Freescale Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Freescale Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. "Typical" parameters that may be provided in Freescale Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals", must be validated for each customer application by customer's technical experts. Freescale Semiconductor does not convey any license under its patent rights nor the rights of others. Freescale Semiconductor products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Freescale Semiconductor product could create a situation where personal injury or death may occur. Should Buyer purchase or use Freescale Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold Freescale Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Freescale Semiconductor was negligent regarding the design or manufacture of the part.

Freescale <sup>™</sup> and the Freescale logo are trademarks of Freescale Semiconductor, Inc. All other product or service names are the property of their respective owners. © Freescale Semiconductor, Inc. 2006. All rights reserved.

